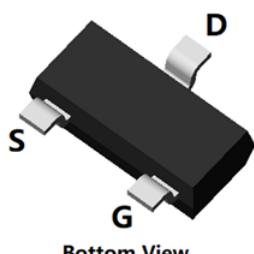
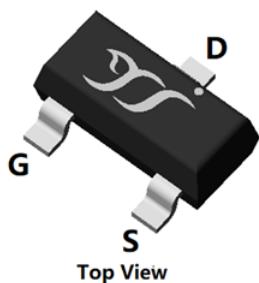
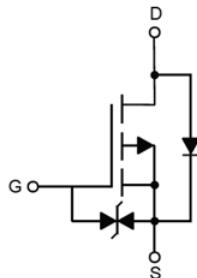




P-Channel Enhancement Mode Field Effect Transistor

**SOT-23**

Product Summary

- V_{DS} -60V
- I_D -1.8A
- $R_{DS(ON)}$ (at $V_{GS}=-10V$) $<169m\Omega$
- $R_{DS(ON)}$ (at $V_{GS}=-4.5V$) $<250m\Omega$
- ESD Protected Up to 2kV (HBM)

General Description

- Voltage controlled small signal switch
- Low input Capacitance
- Fast Switching Speed
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Battery operated systems
- Solid-state relays
- Direct logic-level interface:TTL/CMOS

■ Limiting Values

Parameter	Conditions		Symbol	Min	Max	Unit
Drain-source Voltage			V_{DS}	-	-60	V
Gate-source Voltage			V_{GS}	-20	20	
Continuous Drain Current (Note 1,2)	Steady-State	$T_A=25^\circ C, V_{GS}=-10V$	I_D	-	-1.8	A
		$T_A=100^\circ C, V_{GS}=-10V$		-	-1.1	
Pulsed Drain Current	$T_A=25^\circ C, t_p \leq 10\mu s$		I_{DM}	-	-15	
Maximum Body-Diode Continuous Current	$T_A=25^\circ C$		I_S		-1.2	
Total Power Dissipation (Note 1,2)	Steady-State	$T_A=25^\circ C$	P_D	-	1	W
		$T_A=100^\circ C$		-	0.4	
Junction and Storage Temperature Range			T_J, T_{STG}	-55	150	°C

■ Thermal Resistance

Parameter	Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient (Note 2)	$R_{\theta JA}$	-	115	°C/W

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJL169P06AK	F2	16906.	3000	30000	120000	7" reel



YJL169P06AK

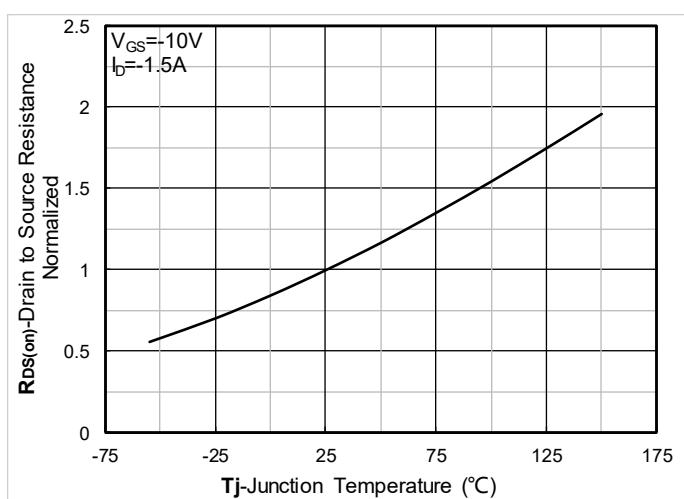
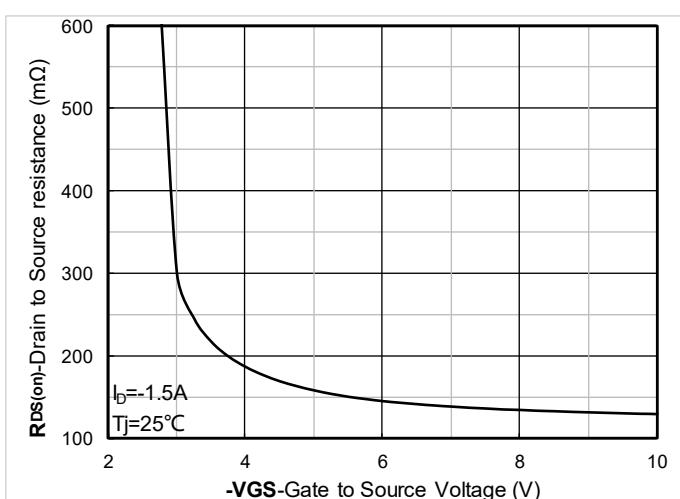
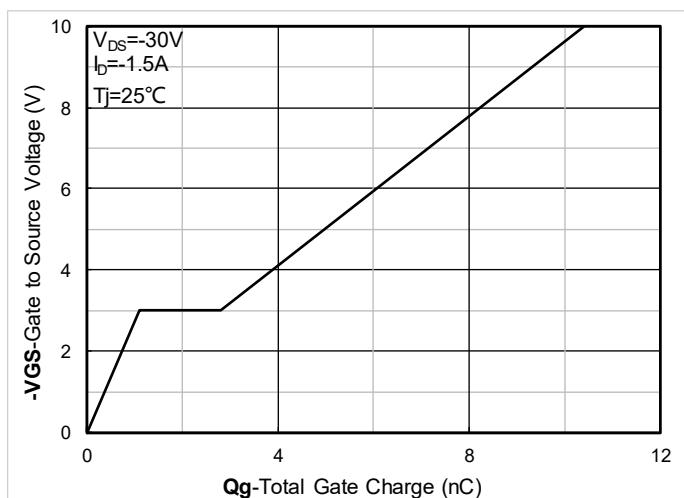
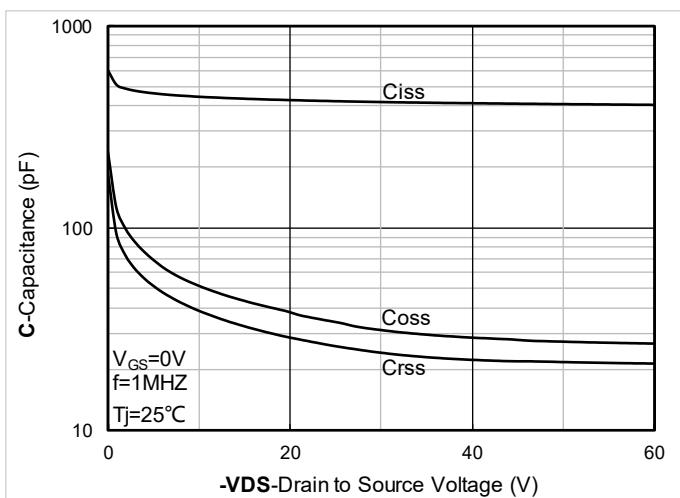
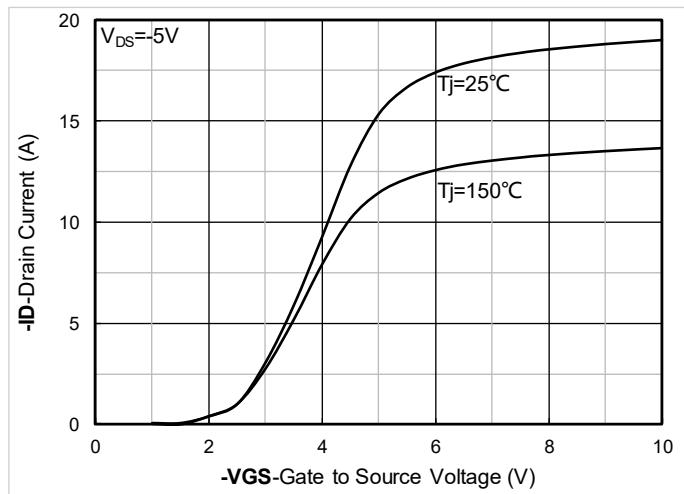
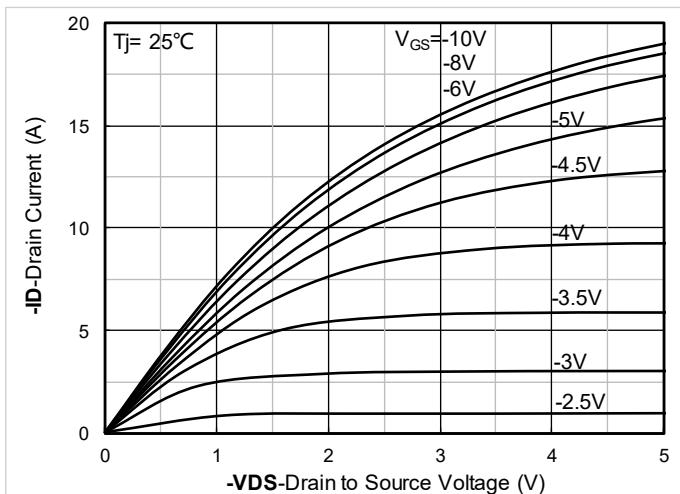
■ Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A, T_j=25^\circ C$	-60	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-60V, V_{GS}=0V, T_j=25^\circ C$	-	-	-1	μA
		$V_{DS}=-60V, V_{GS}=0V, T_j=150^\circ C$	-	-	-100	
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V, T_j=25^\circ C$	-	-	± 10	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A, T_j=25^\circ C$	-1.1	-1.6	-2.1	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-1.5A, T_j=25^\circ C$	-	130	169	$m\Omega$
		$V_{GS}=-4.5V, I_D=-0.7A, T_j=25^\circ C$	-	166	250	$m\Omega$
Diode Forward Voltage	V_{SD}	$I_S=-1.2A, V_{GS}=0V, T_j=25^\circ C$	-	-0.81	-1.2	V
Gate Resistance	R_G	$f=1MHz, T_j=25^\circ C$	-	8	-	Ω
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{DS}=-30V, V_{GS}=0V, f=1MHz, T_j=25^\circ C$	-	419	-	pF
Output Capacitance	C_{oss}		-	31	-	
Reverse Transfer Capacitance	C_{rss}		-	24	-	
Switching Parameters						
Total Gate Charge	Q_g	$V_{GS}=-10V, V_{DS}=-30V, I_D=-1.5A, T_j=25^\circ C$	-	10.4	-	nC
Gate-Source Charge	Q_{gs}		-	1.1	-	
Gate-Drain Charge	Q_{gd}		-	1.7	-	
Reverse Recovery Charge	Q_{rr}	$I_F=-1.5A, di/dt=100A/\mu s, V_{GS}=0V, V_R=-30V, T_j=25^\circ C$	-	19	-	nC
Reverse Recovery Time	t_{rr}		-	19	-	ns
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=-10V, V_{DS}=-30V, I_D=-1.5A, R_{GEN}=3\Omega, T_j=25^\circ C$	-	6	-	ns
Turn-on Rise Time	t_r		-	3	-	
Turn-off Delay Time	$t_{D(off)}$		-	21	-	
Turn-off Fall Time	t_f		-	5	-	

Note:

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
2. The value of $R_{\theta JA}$ is measured with the device mounted on the 40mm*40mm*1.1mm single layer FR-4 PCB board with 1 in² pad of 2oz. Copper, in the still air environment with $T_A=25^\circ C$. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.

■ Typical Electrical and Thermal Characteristics Diagrams



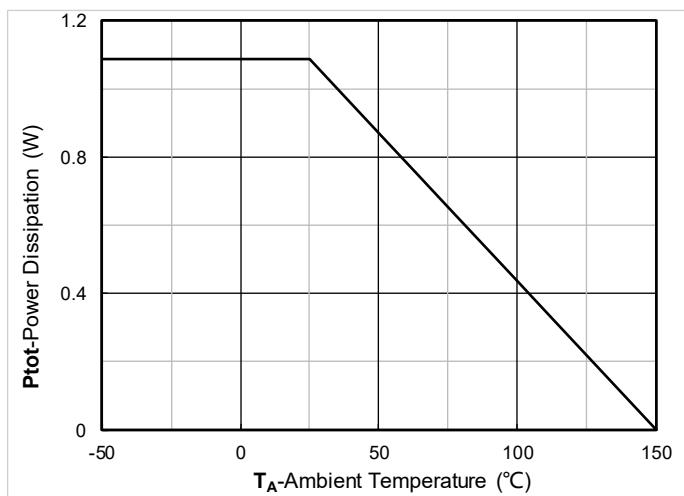
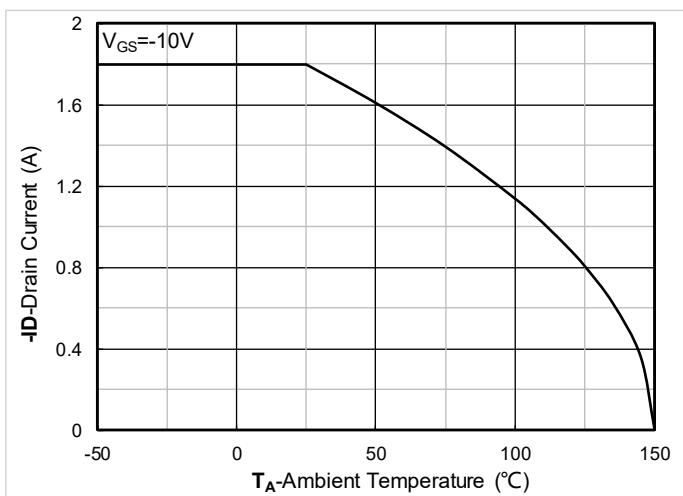
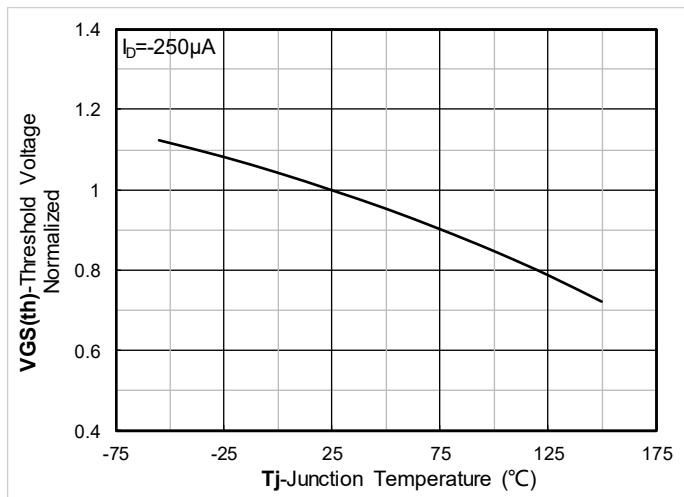
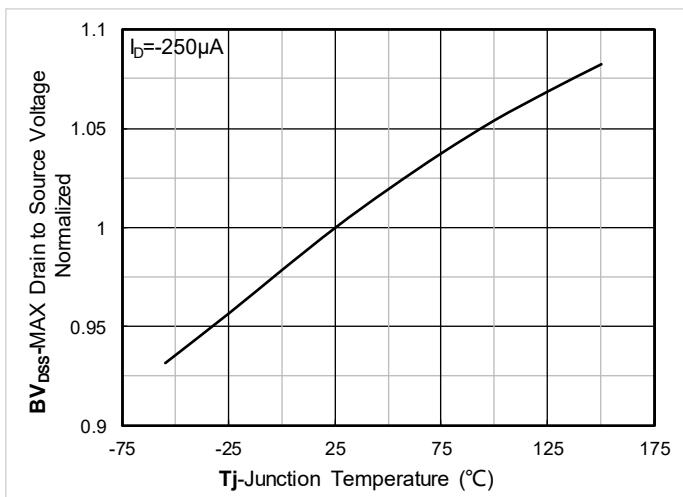
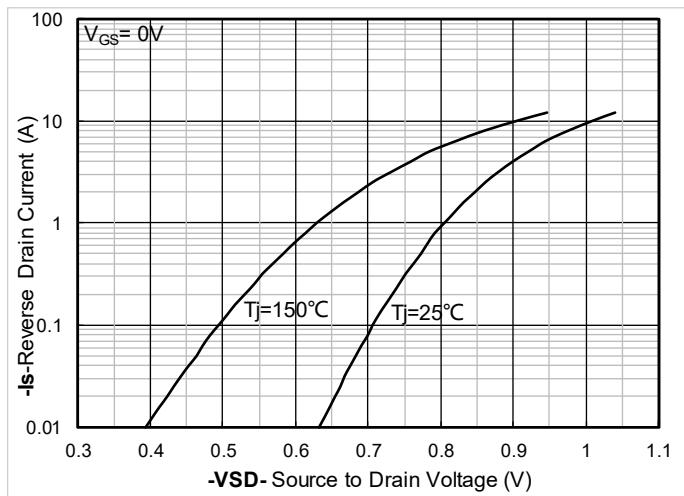
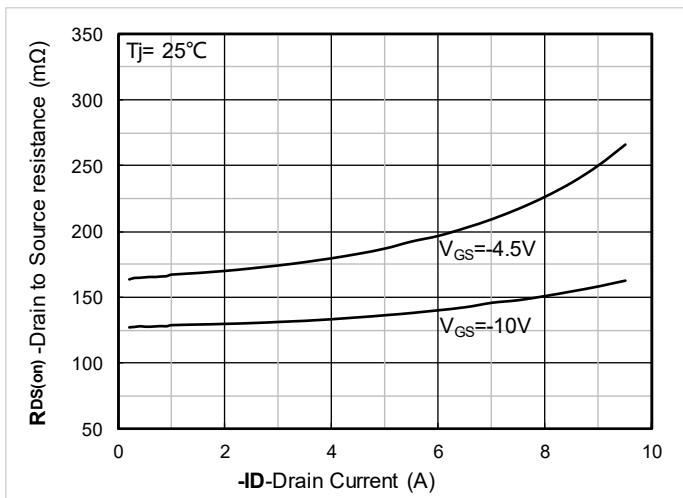


Figure 11. Current dissipation

Figure 12. Power dissipation

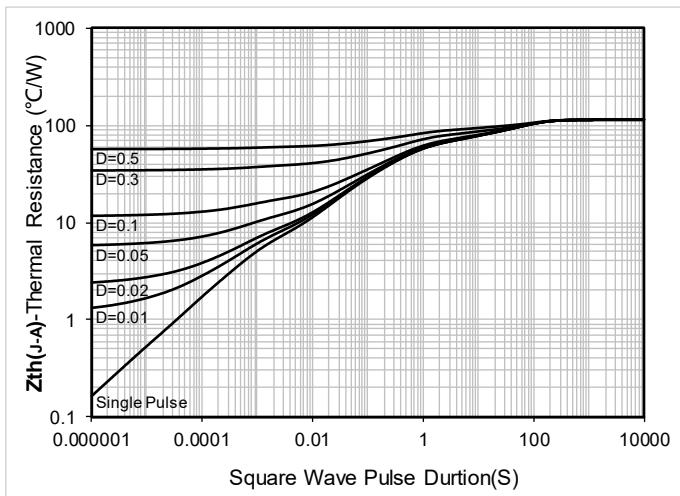


Figure 13. Maximum Transient Thermal Impedance

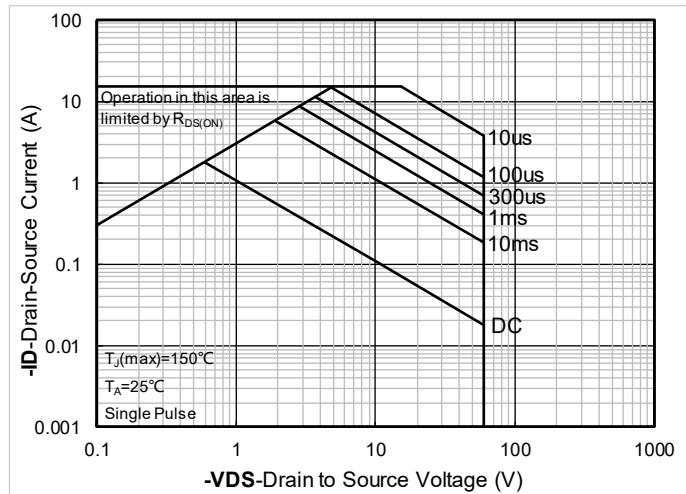
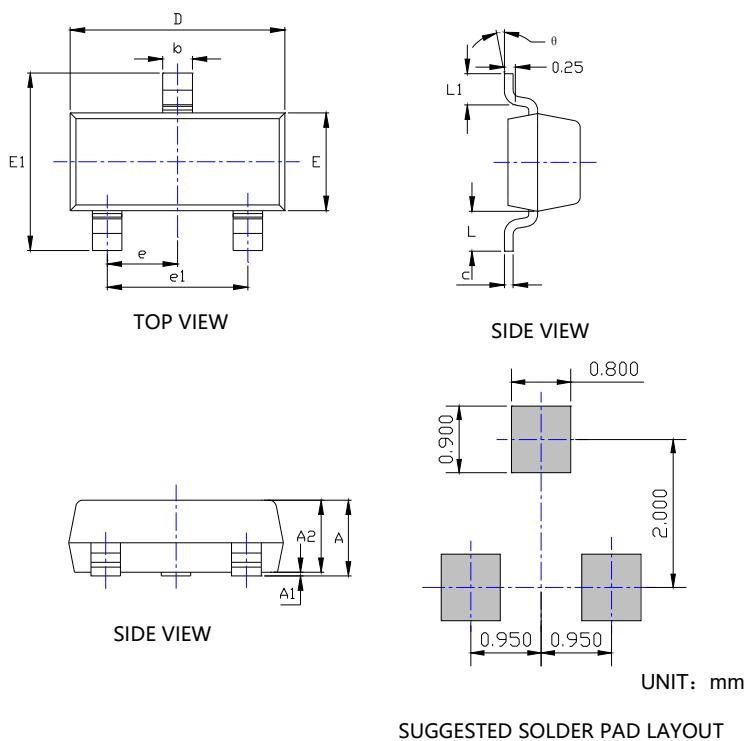


Figure 14. Safe Operation Area



■ SOT-23 Package Information



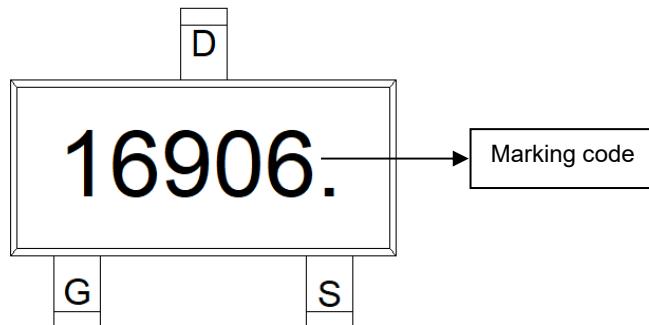
SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
MIN.	MAX.	MIN.	MAX.	
A	0.035	0.045	0.900	1.150
A1	0.000	0.004	0.000	0.100
A2	0.035	0.041	0.900	1.050
b	0.012	0.020	0.300	0.500
c	0.004	0.008	0.100	0.200
D	0.110	0.118	2.800	3.000
E	0.047	0.055	1.200	1.400
E1	0.089	0.100	2.250	2.550
e	0.037TYP		0.950TYP	
e1	0.071	0.079	1.800	2.000
L	0.022REF		0.550REF	
L1	0.012	0.020	0.300	0.500
θ	0°	8°	0°	8°

NOTE:

- 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
- 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
- 3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.



■ Marking Information



Note:

1. All marking is at middle of the product body
2. All marking is in laser printing
3. 16906. is marking code
4. Body color: Black



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